

3rd International Symposium on *Intelligence Design*

March 13(Mon.) – 14 (Tue.), 2023
University of Fukui | Online



The 3rd International Symposium on Intelligence Design (ISID 2023) is an international conference for researchers from various research fields to discuss the potential future of artificial intelligence and design. This symposium aims to introduce the latest research findings by world-class researchers who lead innovation design and research and discuss unexplored research areas in the field and the possibility of approaching new issues. ISID is hosted by University of Fukui, JAIST Co-AI Design Research Center, and supported by the grant from JAIST Co-AI Design Research Core. **ISID 2023 is a totally online event, is free to register.**

Important Date

Poster Submission (only abstract): February 20, 2023
Registration: until March.8, 2023
Symposium: March. 13-14, 2023

Call for Posters

The Symposium on Intelligence Design invites exciting work as a poster presentation; work-in-progress, or partially finished work in design and AI-related topics are also welcomed. Only abstract submission is required without a manuscript (upload of pdf file is optional).

Key Speakers

[Keynote] XU ZHEN (Tianjin University, CHINA)
[Keynote] Bernd Bickel (IST Austria, Austria)
[Keynote] Hideyuki Takagi (Kyushu University, JAPAN)
Mohammed Al-Sada (Qatar University)
Hsin-Ruey Tsai (National Chengchi University)
Zeyu Wang (Hong Kong University of Science and Technology)
Chia-Ming Chang (The University of Tokyo)
Christian Arzate Cruz (Ritsumeikan University)
Koya Narumi (The University of Tokyo)
Bojian Wu (Zhejiang University)
Ran Dong (Tokyo University of Technology)
Hao Hua (Southeast University)
Hu Yuchen (Roboticplus)
Chuang Gan (University of Massachusetts Amherst)

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REGISTRATION LINK

